

 $4.1 \ge 1.0 \mathrm{mm}$ RIGHT ANGLE SMD CHIP

LED LAMP

Features

- $\bullet 4.1 \mathrm{mm} \ \mathrm{x} \ 1.0 \mathrm{mm}$ RIGHT ANGLE SMT LED, $1.52 \mathrm{mm}$ THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- ullet PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- \bullet RoHS COMPLIANT.

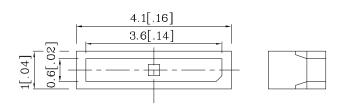


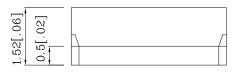


Notes:

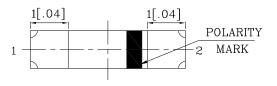
- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (TA=25°C)		VG (InGaAlP)	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	30	mA
Forward Current (peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	150	mA
Power Dissipation	Рт	75	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	C









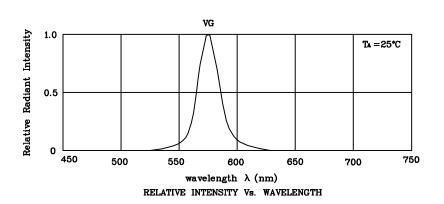
Operating Characteristi (TA=25°C)	VG (InGaAlP)	Unit	
Forward Voltage (Typ.) (IF=20mA)	VF	2.1	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength Of Peak Emission (Typ.) (IF=20mA)	λΡ	574	nm
Wavelength Of Dominant Emission (Typ.) (IF=20mA)	λ D	570	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	20	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	15	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
XZVG90W	Green	InGaAlP	Water Clear	18	59	574	90°
Published Date :	JAN 23,2008	Drawing	No :XDSA3722	V5	Cł	necked : B.L.LIU	P. 1/4

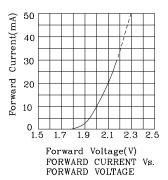


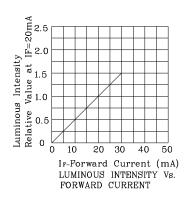
)W

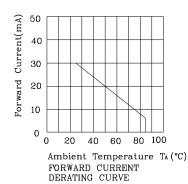
 $4.1 \times 1.0 \mathrm{mm}$ RIGHT ANGLE SMD CHIP LED LAMP

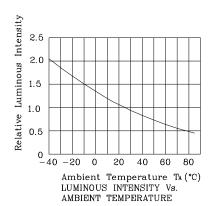


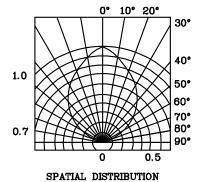
❖ VG









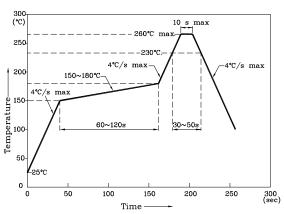




 4.1×1.0 mm RIGHT ANGLE SMD CHIP

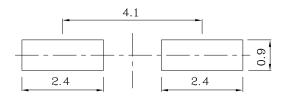
LED LAMP

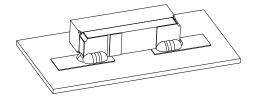
Reflow Soldering Profile For Lead-free SMT Process.



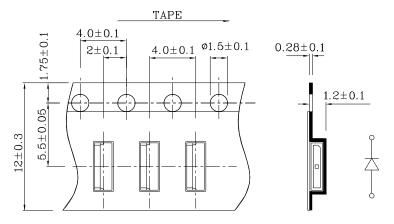
NOTES:

- 1. Maximum soldering temperature should not exceed 260°c.
- 2. Recommended reflow temperature: 145°c-260°c.
- 3. Do not put stress to the epoxy resin during high temperatures conditions.
- **♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)
- ♦ The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

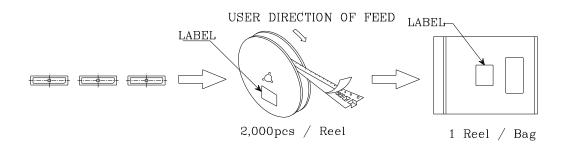


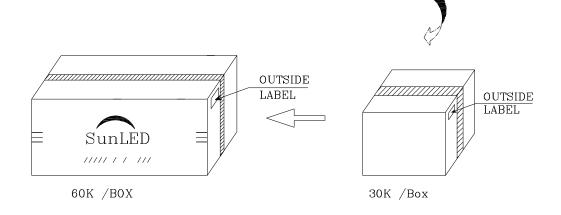
4.1 x 1.0mm RIGHT ANGLE SMD CHIP

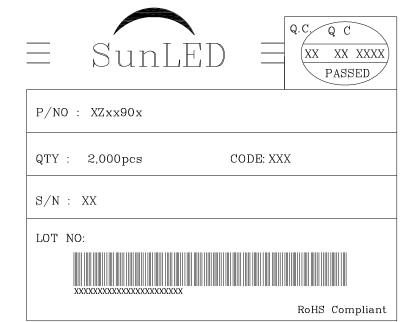
LED LAMP

PACKING & LABEL SPECIFICATIONS

XZVG90W







Published Date : JAN 23,2008 Drawing No :XDSA3722 V5 Checked : B.L.LIU P. 4/4